

## PATENT ASSIGNMENT COVER SHEET

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Assignment ID: PATI511933

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
TECHNOLOGY RESEARCH ASSOCIATION FOR FUTURE ADDITIVE MANUFACTURING	09/11/2024
<b>RECEIVING PARTY DATA</b>	
<b>Company Name:</b>	NIDEC MACHINE TOOL CORPORATION
<b>Street Address:</b>	130, Roku-jizo, Ritto
<b>City:</b>	Shiga
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	520-3080
<b>PROPERTY NUMBERS Total: 2</b>	
<b>Property Type</b>	<b>Number</b>
<b>Patent Number:</b>	10315251
<b>Patent Number:</b>	11007720
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	5187553658
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<b>Correspondent Name:</b>	John LaBatt
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<b>ATTORNEY DOCKET NUMBER:</b>	NIDEC
<b>NAME OF SUBMITTER:</b>	Mr. John LaBatt
<b>SIGNATURE:</b>	Mr. John LaBatt
<b>DATE SIGNED:</b>	09/22/2024
<b>Total Attachments: 1</b>	
source=Assignment signed document_US Reg nos 10315251 & 11007720#page1.tiff	

## ASSIGNMENT OF PATENT RIGHTS

This Agreement is entered into by and between TECHNOLOGY RESEARCH ASSOCIATION FOR FUTURE ADDITIVE MANUFACTURING, having an address of 1-10-4, Kaji-cho, Chiyoda-ku, Tokyo 101-0044, Japan (Assignor) and NIDEC MACHINE TOOL CORPORATION, having an address of 130, Roku-jizo, Ritto, Shiga, 520-3080, Japan (Assignee).

WHEREAS the Assignor is the owner of: U.S. Patent No. 10,315,251, issued 11 June 2019, as a result of an assignment recorded at Reel/Frame 039678/0608; and U.S. Patent No. 11,007,720, issued 18 May 2021, as a result of an assignment recorded at Reel/Frame 047151/0588, "the Patents";

WHEREAS Assignor desires to sell, assign, and transfer all of Assignor's rights, title, and interest in and to the Patents and the inventions and improvements described therein to Assignee.

WHEREAS Assignee desires to obtain all of the rights title, and interest in and to the Patents and the inventions and improvements described therein as the sole owner of the Patents.

NOW THEREFORE, for and in consideration of good and valuable consideration, the receipt and sufficiency of which is hereby expressly acknowledged, the parties agree as follows:

1. Assignor hereby sells, assigns, and otherwise transfers unto Assignee, and its successors, assigns and legal representatives, the rights, title and interest in and to the Patents and the inventions and improvements described therein, and any and all rights and privileges under the Patents, and any reissues, or reexaminations, or extensions of the Patents.
2. Assignor hereby consents that a copy of this Agreement shall be deemed a full legal and formal equivalent of any assignment, consent to file, or like document, which may be required for any purpose and more particularly as proof of the right of the Assignee, its successors, assigns and legal representatives, or to such nominees as the Assignee may designate to take any desired actions.
3. Assignor agrees that, when requested, Assignor will, without charge to the Assignee but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining the Patents and for vesting title thereto in the Assignee, its successors, assigns and legal representatives or nominees.
4. Assignor covenants with the Assignee, its successors, assigns and legal representatives, that the rights and property herein conveyed are free and clear of any encumbrance, and that Assignor has full right to convey the same as herein expressed.

IN WITNESS WHEREOF, Assignor has duly executed this agreement below.

**Assignor:**

TECHNOLOGY RESEARCH ASSOCIATION FOR FUTURE ADDITIVE  
MANUFACTURING

By: Takahisa Kimijima

Name: Takahisa Kimijima

Title: Senior Executive Director

Date: the 11th day of September, 2024